Onsemi

MOSFET – Power, Single N-Channel, DFN5/DFNW5

40 V, 130 A, 2.5 mΩ

NVMFS5C442NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C442NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Parar	neter		Value	Unit
V _{DSS}	Drain-to-Source Voltag	Drain-to-Source Voltage			V
V _{GS}	Gate-to-Source Voltage	e		±20	V
Ι _D	Continuous Drain		$T_{C} = 25^{\circ}C$	130	А
	Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C	95	
PD	Power Dissipation	State	T _C = 25°C	83	W
	R _{θJC} (Note 1)		$T_{\rm C} = 100^{\circ}{\rm C}$	42	
Ι _D	Continuous Drain		$T_A = 25^{\circ}C$	28	А
	Current R _{θJA} (Notes 1, 2, 3)	Steady	T _A = 100°C	20	
PD	Power Dissipation	State	T _A = 25°C	3.7	W
	$R_{\theta JA}$ (Notes 1, 2)		T _A = 100°C	1.8	
I _{DM}	Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	900	А
T _J , T _{stg}	Operating Junction and Storage Temperature Range			–55 to +175	°C
۱ _S	Source Current (Body Diode)			81	А
E _{AS}	Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 10 A)			265	mJ
TL	Lead Temperature for S (1/8" from case for 10 s		Purposes	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Junction-to-Case - Steady State	1.8	°C/W
$R_{\theta JA}$	Junction-to-Ambient - Steady State (Note 2)	41	

The entire application environment impacts the thermal resistance values shown. 1. they are not constants and are only valid for the particular conditions noted.

Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

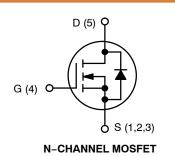
V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	$2.5~\mathrm{m}\Omega$ @ 10 V	130 A
40 V	$3.7~\mathrm{m}\Omega$ @ $4.5~\mathrm{V}$	130 A



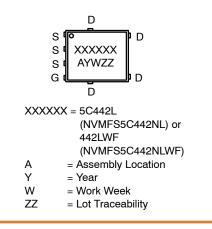
DFN5 (SO-8FL) CASE 488AA



CASE 507BE



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet. NOTE: Some of the devices on this data sheet have been DISCONTINUED. Please refer to the table on page 5.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
OFF CHARA	ACTERISTICS						
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	$V_{GS} = 0 V, I_D$	V_{GS} = 0 V, I_D = 250 μ A				V
V _{(BR)DSS} / T _J	Drain-to-Source Breakdown Voltage Temperature Coefficient				24.8		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0 V, V _{DS} = 40 V	T _J = 25 °C			10	μΑ
		V _{DS} = 40 V	T _J = 125°C			250	
		$V_{GS} = 0 V, V_{DS} = 20$) V, T _J = 125°C			20	1
I _{GSS}	Gate-to-Source Leakage Current	V _{DS} = 0 V, V _{GS} = 20 V				100	nA

V _{GS(TH)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D =$	= 90 μA	1.2		2.0	V
$V_{GS(TH)}/T_J$	Threshold Temperature Coefficient				-5.4		mV/°C
R _{DS(on)}	Drain-to-Source On Resistance	V _{GS} = 10 V	I _D = 50 A		2.0	2.5	mΩ
		V _{GS} = 4.5 V	I _D = 50 A		2.9	3.7	
9 _{FS}	Forward Transconductance	V _{DS} = 15 V, I _D = 50 A			116		S

CHARGES, CAPACITANCES & GATE RESISTANCE

C _{ISS}	Input Capacitance		3100	pF
C _{OSS}	Output Capacitance	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 25 V	1100	
C _{RSS}	Reverse Transfer Capacitance		37	
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 4.5 V, V_{DS} = 32 V; I_{D} = 50 A	23	nC
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 10 V, V_{DS} = 32 V; I_{D} = 50 A	50	
Q _{G(TH)}	Threshold Gate Charge		5.0	
Q _{GS}	Gate-to-Source Charge		9.8	
Q _{GD}	Gate-to-Drain Charge	V _{GS} = 4.5 V, V _{DS} = 32 V; I _D = 50 A	6.7	
V _{GP}	Plateau Voltage		3.1	V

SWITCHING CHARACTERISTICS (Note 5)

t _{d(ON)}	Turn–On Delay Time		12	ns
t _r	Rise Time	V _{GS} = 4.5 V, V _{DS} = 32 V,	8.3	
t _{d(OFF)}	Turn-Off Delay Time	$I_{\rm D} = 50 \text{ A}, \text{ R}_{\rm G} = 1.0 \Omega$	28	
t _f	Fall Time		9.4	

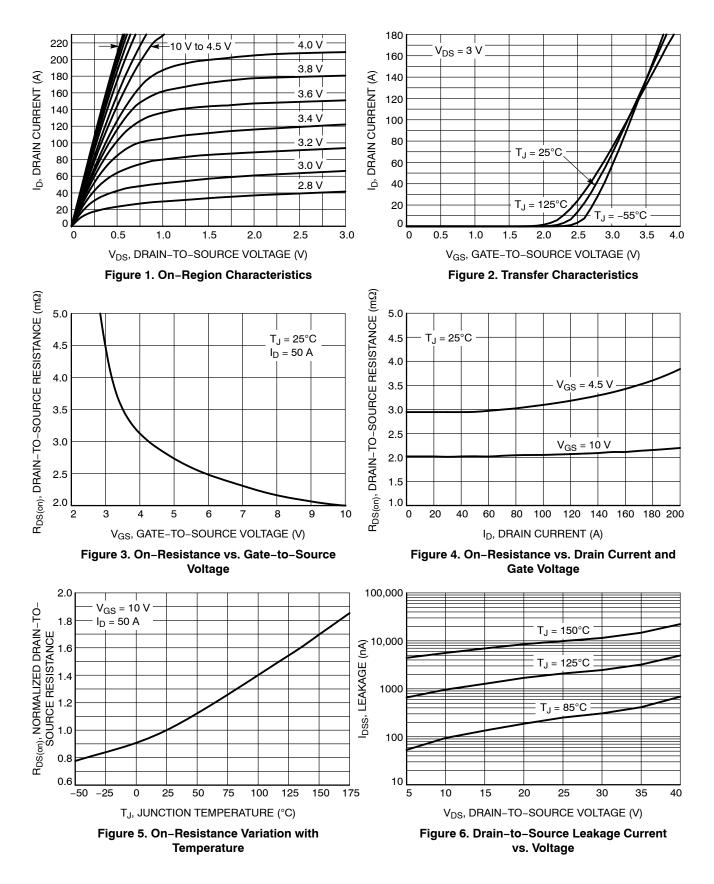
DRAIN-SOURCE DIODE CHARACTERISTICS

V _{SD}	Forward Diode Voltage	V _{GS} = 0 V,	$T_J = 25^{\circ}C$	0.85	1.2	V
		I _S = 50 A	T _J = 125°C	0.73		
t _{RR}	Reverse Recovery Time			46		ns
t _a	Charge Time	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 50 A		23		
t _b	Discharge Time			23		
Q _{RR}	Reverse Recovery Charge			40		nC

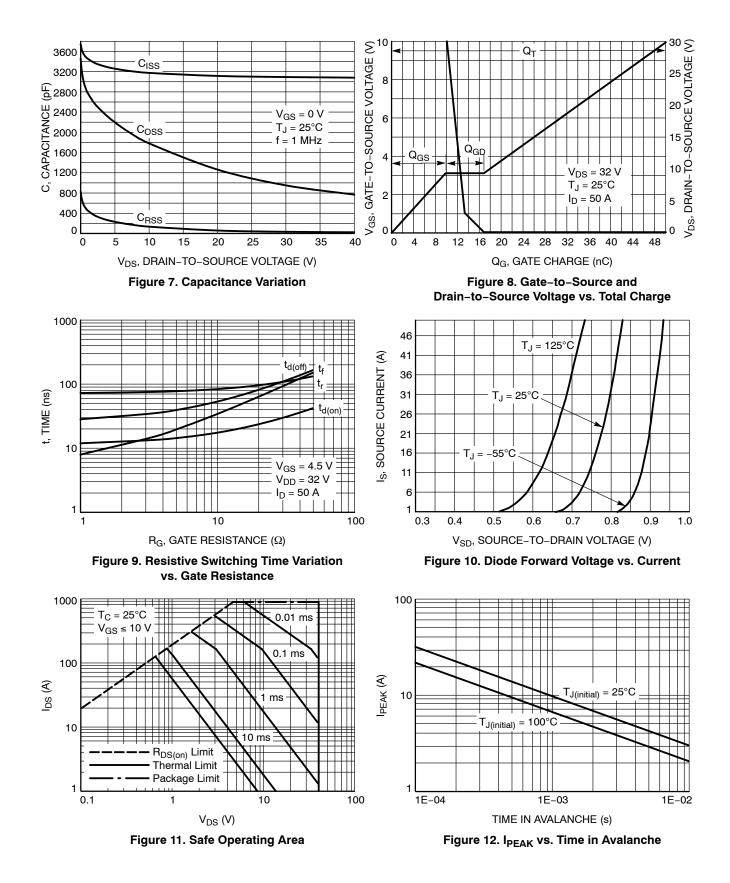
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

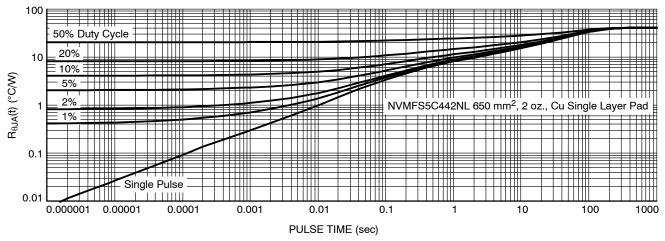


Figure 13. Thermal Characteristics

Device	Marking	Package	Shipping [†]
NVMFS5C442NLWFT1G	442LWF	DFNW5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C442NLT3G	5C442L	DFN5 (Pb-Free)	5000 / Tape & Reel
NVMFS5C442NLAFT1G	5C442L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C442NLAFT1G-YE	5C442L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C442NLWFAFT1G	442LWF	DFNW5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C442NLWFET1G	442LWF	DFNW5 (Pb-Free)	1500 / Tape & Reel

DEVICE ORDERING INFORMATION

DISCONTINUED (Note 6)

NVMFS5C442NLT1G	5C442L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C442NLWFT3G	442LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

6. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.

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